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SPC TYPE NO.	PINS		A	B	C	D	E	F	G
	Num.	Fig.							
SPC4178	15	1	30.80	24.99	16.34	19.20	2.29	19.00	25.0
SPC4179	26	2	39.20	33.32	24.70	27.70	2.29	27.00	33.3
SPC4180	44	2	53.00	47.04	38.40	41.10	2.29	41.00	47.0
SPC4181	62	2	69.40	63.50	54.80	57.30	2.41	58.00	63.5

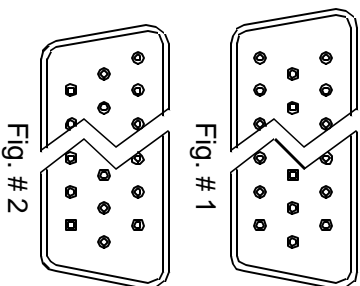
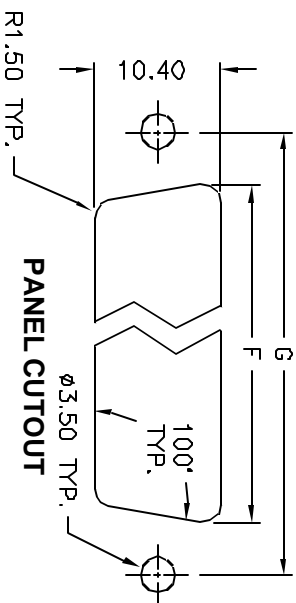
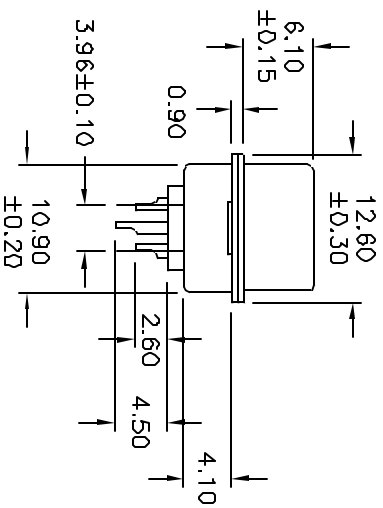
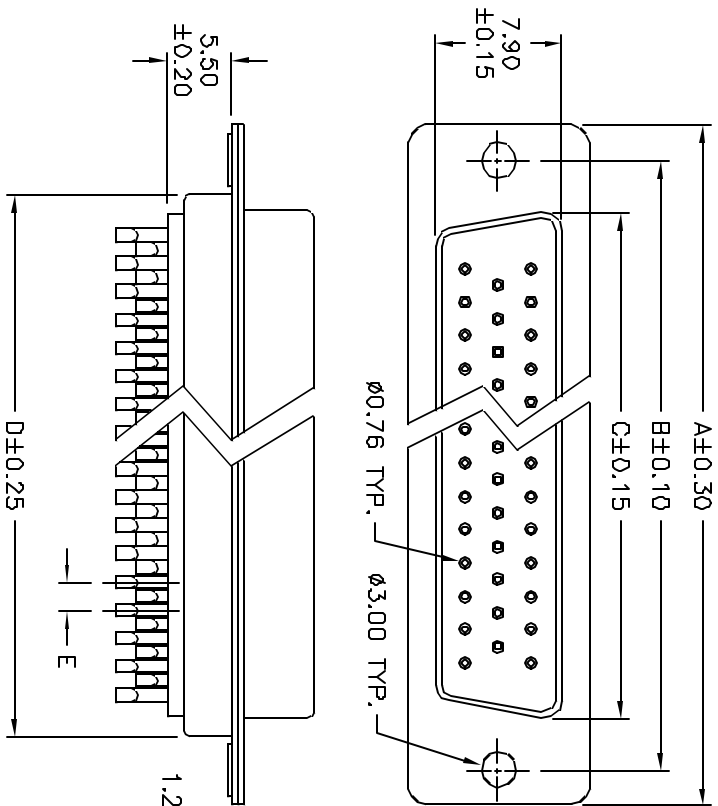
REVOLUTIONS		DOC. NO.	DATE	CHECKED	DATE	APPRVD	DATE
DCP #	REV	DESCRIPTION	DRAWN	DATE	CHECKED	DATE	APPRVD
522	A	RELEASED	HO	4/19/02	JWM	6/5/02	DJC

MATERIAL:

1. Shell: Steel, Tin Plated
2. Insulator: PBT +30 % Fiber Glass, Black UL94V-0 Rated
3. Contact: Brass, Stamped-Pin
Gold-Plated on Contact Area
Tin-Lead on Solder Cup

SPECIFICATION:

1. Current Rating: 5 Amps
2. Contact Resistance: 15 milliohms Max.
3. Insulator Resistance: 1000 Megohms Min.
4. Voltage: 500V AC for 1 Minute
5. Temperature: -50°C to +100°C



DISCLAIMER
ALL DIMENSIONS AND TECHNICAL INFORMATION CONTAINED HEREIN ARE BASED UPON INFORMATION AND/OR TESTS WE BELIEVE TO BE ACCURATE AND RELIABLE. SINCE CONDITIONS OF USE ARE BEYOND OUR CONTROL, THE USER SHALL DETERMINE THE SUITABILITY OF THE PRODUCT FOR THE INTENDED USE AND ASSURE ALL RISK AND LIABILITY WHEREASER IN CONNECTION THEREWITH.



SPC TECHNOLOGY

Tolerances Unless Otherwise Specified
Decimals
.X ±0.2
.XX ±0.12

DRAWING TITLE:
High Density D-Sub, Female, Solder Type

DRAWN BY:	HISHAM ODISH	DATE:	4/19/02
CHECKED BY:	JEFF MCYCKER	DATE:	6/5/02
APPROVED BY:	DANIEL CAREY	DATE:	6/5/02

SIZE	DWG. NO.	ELECTRONIC FILE	REV
A	TA-521	TA-521.DWG	A
SCALE:	NTS	U.O.M.: Millimeters	SHEET: 1 OF 1